

# QUICKSWITCH<sup>®</sup> PRODUCTS HIGH-PERFORMANCE CMOS ANALOG FOUR-CHANNEL SPST SWITCH WITH INDIVIDUAL ENABLES

### IDTQS4A101

### **FEATURES:**

- Low ON resistance: rbs(on) = 5Ω
- Wide bandwidth: 1.4GHz (-3dB point)
- Crosstalk: 122dB at 50KHz, -80dB at 5MHz, -65dB at 30MHz
- Off-isolation: -100dB at 50KHz, -75dB at 5MHz, -45dB at 30MHz
- Single 5V supply
- Bidirectional signal flow
- TTL-compatible control inputs
- Ultra-low quiescent current: 3µA
- Switch turn on time of 6.5ns
- Available in QSOP package

### **APPLICATIONS:**

· High-speed video signal switching/routing

FUNCTIONAL BLOCK DIAGRAM

- Audio signal switching/routing
- Data acquisition
- ATE systems
- Telecomm routing
- Token Ring transceivers
- · High-speed networking

# **DESCRIPTION:**

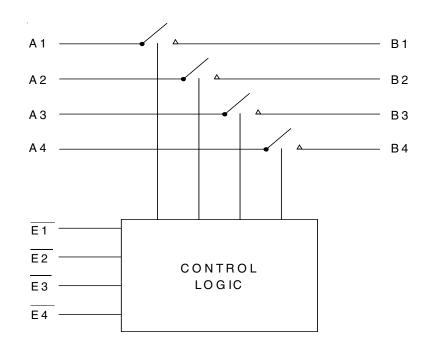
The QS4A101 is a high-performance CMOS analog four-channel SPST switch with individual enables. This device provides a set of four high-speed CMOS switches connecting inputs to outputs. The low ON resistance of the QS4A101 allows inputs to be connected to outputs with low insertion loss and high bandwidth.

The QS4A101, with 1.4GHz bandwidth, is ideal for high-performance video signal switching, audio signal switching, and telecomm routing applications. Low power dissipation makes this device ideal for battery operated and remote instrumentation applications.

The QS4A101 is offered in the QSOP package which has several advantages over conventional packages such as PDIP and SOIC, including:

- Reduced signal delays due to denser component packaging on circuit boards
- · Reduced system noise due to less pin inductance

The QS4A101 is characterized for operation at -40°C to +85°C.

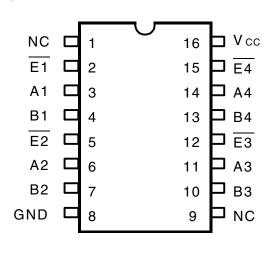


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#### INDUSTRIAL TEMPERATURE RANGE

### **APRIL 2014**

### **PIN CONFIGURATION**



QSOP TOP VIEW

# ABSOLUTE MAXIMUM RATINGS<sup>(1)</sup>

| Symbol               | Description                          | Max         | Unit |  |
|----------------------|--------------------------------------|-------------|------|--|
| VTERM <sup>(2)</sup> | Supply Voltage to Ground             | –0.5 to +7  | V    |  |
| VTERM <sup>(3)</sup> | DC Switch Voltage Vs                 | -0.5 to +7  | V    |  |
| —                    | Analog Input Voltage                 | –0.5 to +7  | V    |  |
| VTERM <sup>(3)</sup> | DC Input Voltage VIN                 | -0.5 to +7  | V    |  |
| VAC                  | AC Input Voltage (pulse width ≤20ns) | _3          | V    |  |
| Ιουτ                 | DC Output Current                    | 120         | mA   |  |
| Рмах                 | Maximum Power Dissipation            | 0.7         | W    |  |
| TSTG                 | Storage Temperature                  | -65 to +150 | °C   |  |

NOTES:

 Stresses greater than those listed under ABSOLUTE MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

2. Vcc terminals.

3. All terminals except Vcc .

# **PIN DESCRIPTION**

| Pin Names | I/O | Description        |
|-----------|-----|--------------------|
| A1 -A4    | I/O | Port A             |
| B1 -B4    | I/O | Port B             |
| Ē1 -Ē4    | I   | Port Switch Enable |

### **FUNCTION TABLE(1)**

| Ē | А | В | Function   |  |
|---|---|---|------------|--|
| L | Н | Н | Connect    |  |
| L | L | L | Connect    |  |
| Н | Х | Х | Disconnect |  |

NOTE:

1. H = HIGH Voltage Level

L = LOW Voltage Level

X = Don't Care

# **POWER SUPPLY CHARACTERISTICS**

| Symbol | Parameter      | Test Conditions              | Max. | Unit |
|--------|----------------|------------------------------|------|------|
| Icc    | Supply Current | Vcc = Max., Vin = GND or Vcc | 3    | μA   |

# DC ELECTRICAL CHARACTERISTICS OVER OPERATING RANGE

Following Conditions Apply Unless Otherwise Specified: Industrial: TA =  $-40^{\circ}$ C to  $+85^{\circ}$ C, Vcc = 5V ± 5%

| Symbol      | Parameter                                   | Test Conditions                                    | Min. | Typ. <sup>(1)</sup> | Max.    | Unit |
|-------------|---|--|------|---------------------|---------|------|
| Analog S    | witch                                       |  |      |                     |         |      |
| Vin         | Analog Signal Range <sup>(2)</sup>          |  | -0.5 | 1                   | Vcc - 1 | V    |
| rds(on)     | Drain-source ON resistance <sup>(2,3)</sup> | Vcc = Min., VIN = 0V, ION = 30mA                   | —    | 5                   | 7       | Ω    |
|             |   | Vcc = Min., VIN = 2.4V, ION = 15mA                 | —    | 13                  | 17      |      |
| IC(OFF)     | Channel Off Leakage Current                 | A = Vcc or 0V, B = 0V or Vcc, $\overline{E}$ = Vcc | —    | 1                   | _       | nA   |
| IC(ON)      | Channel On Leakage Current                  | A = B = 0V   | -    | 1                   | _       | nA   |
|             |   | (each channel is turned on sequentially)           |      |                     |         |      |
| Digital Co  | ontrol                                      |  |      |                     |         |      |
| Vih         | Input HIGH Voltage                          | Guaranteed Logic HIGH for Control Pins             | 2    | —                   | _       | V    |
| VIL         | Input LOW Voltage                           | Guaranteed Logic LOW for Control Pins              | —    | _                   | 0.8     | V    |
| Dynamic     | Characteristics                             |  | ·    |                     | -       |      |
| ton(Ē)      | Enable Turn-On Time                         | $RL = 1K\Omega$ , $CL = 100pF$                     | 0.5  | -                   | 6.5     | ns   |
|             | Ē to A, B                                   | (See Switching Time)                               |      |                     |         |      |
| toff(Ē)     | Enable Turn-Off Time                        | $RL = 1K\Omega$ , $CL = 100pF$                     | 0.5  | -                   | 6       | ns   |
|             | Ē to A, B                                   | (See Switching Time)                               |      |                     |         |      |
| <b>t</b> PD | Group Delay <sup>(2,4a)</sup>               | $RL = 1K\Omega$ , $CL = 100pF$                     | —    | _                   | 250     | ps   |
| f3dB        | -3dB Bandwidth                              | VIN = 0 to 1V, 1Vp-p, RL = $75\Omega$              | —    | 1.4                 | _       | GHz  |
|             | Off-isolation                               | VIN = 0 to 1V, 1Vp-p, RL = 75Ω, f = 5.5MHz         | —    | -80                 | _       | dB   |
| XTALK       | Crosstalk                                   | VIN = 0 to 1V, 1Vp-p, RL = 75Ω, f = 30MHz          | —    | -75                 | _       | dB   |
| C(OFF)      | Switch Off Capacitance                      | $\overline{E}$ = Vcc, VIN = VOUT = 0V              | —    | 5                   | _       | pF   |
| C(ON)       | Switch On Capacitance                       | $\overline{E} = 0V, VIN = VOUT = 0V$               | —    | 10                  | _       | pF   |
| QCI         | Charge Injection                            |  |      | 1.5                 | _       | рC   |

NOTES:

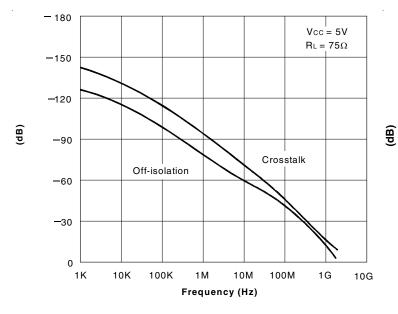
1. Typical values are at Vcc = 5.0V, TA = 25°C.

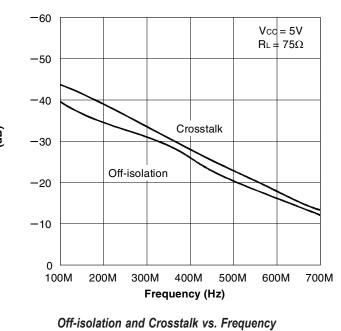
2. Max value is guaranteed but not production tested.

3. Measured by voltage drop between A and C pins at indicated current through the switch ON resistance is determined by the lower of the voltages on the two (A, B) pins.

4. The bus switch contributes no group delay other than the RC delay of the ON resistance of the switch and load capacitance. Group delay of the bus switch, when used in a system, is determined by the driving circuit on the driving side of the switch and its interaction with the load on the driven side.

### **TYPICAL CHARACTERISTICS**



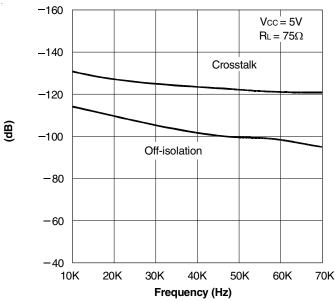


#### Off-isolation and Crosstalk vs. Frequency

NOTES:

1. Crosstalk = 20 log |Vo/Vs|

2. Off-isolation = 20 log |Vo/Vs|



Off-isolation and Crosstalk vs. Frequency

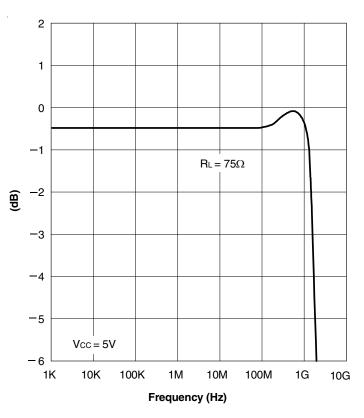
#### NOTES:

1. Crosstalk = 20 log |Vo/Vs|

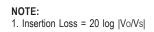
2. Off-isolation = 20 log |Vo/Vs|

1. Crosstalk = 20 log |Vo/Vs| 2. Off-isolation = 20 log |Vo/Vs|

NOTES:

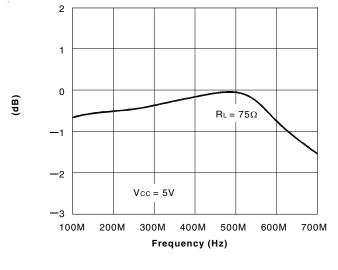


### Insertion Loss vs. Frequency

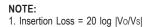


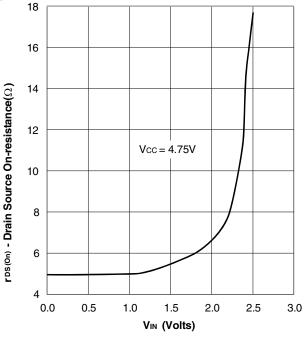
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# **TYPICAL CHARACTERISTICS (CONTINUED)**



Insertion Loss vs. Frequency

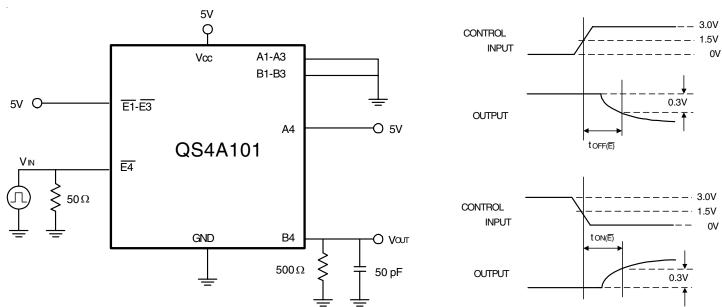




**On-Resistance vs. VIN** 



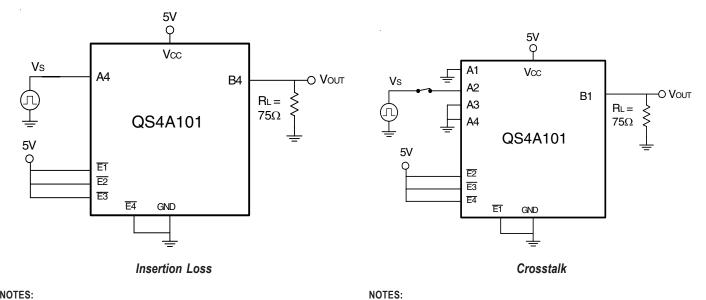




Switching Time

5

# **TEST CIRCUITS (CONTINUED)**



1. Crosstalk = 20 log |Vo/Vs|

2. All unused pins are grounded.

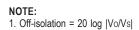
#### NOTES:

1. Insertion Loss = 20 log |Vo/Vs|

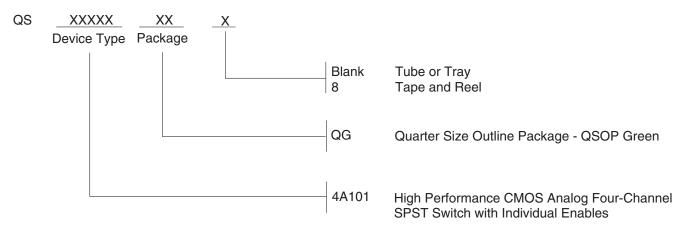
2. All unused pins are grounded.

5V Q Vs A1 Vcc A2 -O Vout B1 AЗ RL = (Л 75Ω A4 Ŧ QS4A101 5V Q Ē1 B2 Ē2 B3 Ē3 Ē4 GND B4

**Off-Isolation** 



### **ORDERING INFORMATION**



# **DATASHEET DOCUMENT HISTORY**

04/13/2014 Pg. 7 Updated the Ordering Information by removing non green package version and Adding Tape and Reel information.

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